



Manual

HIMax[®]

X-DO 32 51

Digital Output Module



All of the HIMA products mentioned in this manual are trademark protected. This also applies for other manufacturers and their products which are mentioned unless stated otherwise.

HIQuad®, HIQuad®X, HIMax®, HIMatrix®, SILworX®, XMR®, HICore® and FlexSILon® are registered trademarks of HIMA Paul Hildebrandt GmbH.

All of the technical specifications and information in this manual were prepared with great care and effective control measures were employed for their compilation. For questions, please contact HIMA directly. HIMA appreciates any suggestion on which information should be included in the manual.

Equipment subject to change without notice. HIMA also reserves the right to modify the written material without prior notice.

All the current manuals can be obtained upon request by sending an e-mail to: documentation@hima.com.

© Copyright 2019, HIMA Paul Hildebrandt GmbH

All rights reserved.

Contact

HIMA Paul Hildebrandt GmbH

P.O. Box 1261

68777 Brühl

Phone: +49 6202 709-0

Fax: +49 6202 709-107

E-mail: info@hima.com

Document designation	Description
HI 801 182 D, Rev. 11.00 (1942)	German original document
HI 801 183 E, Rev. 11.00.00 (1948)	English translation of the German original document

Table of Contents

1	Introduction	5
1.1	Structure and Use of This Manual	5
1.2	Target Audience	5
1.3	Writing Conventions	6
1.3.1	Safety Notices	6
1.3.2	Operating Tips	7
2	Safety	8
2.1	Intended Use	8
2.1.1	Environmental Requirements	8
2.1.2	ESD Protective Measures	8
2.2	Residual Risk	8
2.3	Safety Precautions	8
3	Product Description	9
3.1	Safety Function	9
3.1.1	Response in the Event of a Fault	9
3.2	Scope of Delivery	9
3.3	Type Label	10
3.4	Structure	11
3.4.1	Block Diagram	12
3.4.2	Indicators	13
3.4.3	Module Status Indicators	15
3.4.4	System Bus Indicators	16
3.4.5	I/O Indicators	16
3.5	Product Data	17
3.6	Connector Boards	20
3.6.1	Mechanical Coding of Connector Boards	20
3.6.2	Coding of X-CB 009 5x Connector Boards	21
3.6.3	Connector Boards with Screw Terminals	22
3.6.4	Terminal Assignment for Connector Boards with Screw Terminals	23
3.6.5	Connector Boards with Cable Plug	24
3.6.6	Pin Assignment for Connector Boards with Cable Plug	25
3.7	System Cable X-CA 006	26
3.7.1	Cable Plug Coding	26
4	Start-Up	27
4.1	Mounting	27
4.1.1	Wiring Unused Outputs	27
4.2	Mounting and Removing the Module	28
4.2.1	Mounting a Connector Board	28
4.2.2	Mounting and Removing a Module	30
4.3	Configuring the Module in SILworX	32
4.3.1	The Module Tab	33
4.3.2	The I/O Submodule DO 32_51 Tab	34
4.3.3	The I/O Submodule DO 32_51: Channels Tab	35
4.3.4	Description of <i>Submodule Status [DWORD]</i>	35

4.3.5	Description of <i>Diagnostic Status</i> [DWORD]	36
4.4	Connection Variants	37
4.4.1	1-Pole Wiring of Actuators	37
4.4.2	2-Pole Wiring of Actuators	37
4.4.3	Wiring Actuators to Redundant Modules	38
4.4.4	Wiring Inductive Loads	38
4.4.5	Connecting to Actuators via Field Termination Assembly	39
5	Operation	40
5.1	Handling	40
5.2	Diagnostics	40
6	Maintenance	41
6.1	Maintenance Measures	41
7	Decommissioning	42
8	Transport	43
9	Disposal	44
	Appendix	45
	Glossary	45
	Index of Figures	46
	Index of Tables	47
	Index	48

1 Introduction

This manual describes the technical characteristics of the module and its use. It provides information on how to install, start up and configure the module in SILworX.

1.1 Structure and Use of This Manual

The content of this manual is part of the hardware description of the HIMax programmable electronic system.

This manual contains the following main chapters:

- Introduction
- Safety
- Product description
- Start-up
- Operation
- Maintenance
- Decommissioning
- Transport
- Disposal

Additionally, the following documents must be taken into account:

Document	Content	Document no.
HIMax system manual	Hardware description of the HIMax system	HI 801 001 E
HIMax safety manual	Safety functions of the HIMax system	HI 801 003 E
HIMax maintenance manual	Description of significant operational and maintenance actions.	HI 801 171 E
Communication manual	Description of safeethernet communication and of the available protocols.	HI 801 101 E
Automation security manual	Description of automation security aspects related to the HIMA systems.	HI 801 373 E
SILworX first steps manual	Introduction to SILworX	HI 801 103 E
SILworX online help (OLH)	Instructions on how to use SILworX	---

Table 1: Additional Applicable Manuals

The current manuals can be obtained upon request by sending an e-mail to: documentation@hima.com. Registered customers can download the product documentation from the HIMA Extranet.

1.2 Target Audience

This document is aimed at the planners, design engineers, programmers and the persons authorized to start up, operate and maintain the automation systems. Specialized knowledge of safety-related automation systems is required.

1.3 Writing Conventions

To ensure improved readability and comprehensibility, the following writing conventions are used in this document:

Bold	To highlight important parts. Names of buttons, menu functions and tabs that can be clicked and used in the programming tool.
<i>Italics</i>	Parameters and system variables, references.
<code>Courier</code>	Literal user inputs.
RUN	Operating states are designated by capitals.
Chapter 1.2.3	Cross-references are hyperlinks even if they are not specially marked. In the electronic document (PDF): When the mouse pointer hovers over a hyperlink, it changes its shape. Click the hyperlink to jump to the corresponding position.

Safety notices and operating tips are specially marked.

1.3.1 Safety Notices

Safety notices must be strictly observed to ensure the lowest possible risk.

The safety notices are represented as described below.

- Signal word: warning, caution, notice.
- Type and source of risk.
- Consequences arising from non-observance.
- Risk prevention.

The signal words have the following meanings:

- Warning indicates hazardous situations which, if not avoided, could result in death or serious injury.
- Caution indicates hazardous situation which, if not avoided, could result in minor or moderate injury.
- Notice indicates a hazardous situation which, if not avoided, could result in property damage.

SIGNAL WORD



Type and source of risk!
Consequences arising from non-observance.
Risk prevention.

NOTICE



Type and source of damage!
Damage prevention.

1.3.2 Operating Tips

Additional information is structured as presented in the following example:

i The text giving additional information is located here.

Useful tips and tricks appear as follows:

TIP The tip text is located here.

2 Safety

All safety information, notes and instructions specified in this document must be strictly observed. The product may only be used if all guidelines and safety instructions are adhered to.

The product is operated with SELV or PELV. No imminent risk results from the product itself. Use in the Ex zone is only permitted if additional measures are taken.

2.1 Intended Use

HIMax components are designed for assembling safety-related controller systems.

When using the components in the HIMax system, comply with the following general requirements.

2.1.1 Environmental Requirements

All the environmental requirements specified in this manual must be observed when operating the HIMax system. The environmental requirements are listed in the product data.

2.1.2 ESD Protective Measures

Only personnel with knowledge of ESD protective measures may modify or extend the system or replace components.

NOTICE



Damage to the HIMax system due to electrostatic discharge!

- When performing the work, make sure that the workspace is free of static, and wear a grounding strap.
- If not used, ensure that the components are protected from electrostatic discharge, e.g., by storing them in their packaging.

2.2 Residual Risk

No imminent risk results from a HIMA system itself.

Residual risk may result from:

- Faults related to engineering.
- Faults in the user program.
- Faults related to the wiring.

2.3 Safety Precautions

Observe all local safety requirements and use the protective equipment required on site.

3 Product Description

The X-DO 32 51 is a digital NonSIL output module intended for use in the programmable electronic system (PES) HIMax.

The module is equipped with 32 digital outputs that can be loaded with a nominal current of up to 0.5 A per channel. At high level (H level), a voltage equal to the supply voltage is applied to the corresponding output.

The outputs are suitable for connecting to ohmic, inductive and capacitive loads as well as lamps.

The module can be inserted into any of the base plate slots with the exception of the slots reserved for system bus modules. Refer to the system manual (HI 801 001 E) for details.

It can be operated with safety-related modules and other NonSIL modules within one base plate. Safety-related and NonSIL modules may not be wired redundantly.

The module is interference-free. In particular with respect to EMC, electrical safety, communication to the X-SB and X-CPU modules, and the user program.

Module and connector boards are mechanically coded, see Chapter 3.6.1. Coding prevents installation of unsuitable I/O modules.

Refer to the HIMax safety manual (HI 801 003 E) for further information on the standards used to test and certify the modules and the HIMax system.

The certificates and the EU type test certificate are available on the HIMA website.

3.1 Safety Function

The module does not perform any safety-related functions.

Each switch of a channel can be individually switched off via the system bus (I/O bus).

The parameters and status for this module must not be used for safety functions.

3.1.1 Response in the Event of a Fault

If a channel fault occurs, the affected channel is switched off. If a module fault occurs, all outputs are switched off.

If the system buses fail, the outputs are de-energized.

The module activates the *Error* LED on the front plate.

3.2 Scope of Delivery

To operate, the module must be installed on a matching connector board. If a field termination assembly (FTA) is used, a system cable is required to connect the connector board to the FTA. Connector boards, system cables and FTAs are not included within the scope of delivery.

The connector boards are described in Chapter 3.7, the system cables are described in Chapter 3.8. The FTAs are described in separate manuals.

3.3 Type Label

The type label specifies the following important details:

- Product name
- Mark of conformity
- Bar code (2D or 1D code)
- Part number (Part-No.)
- Hardware revision index (HW-Rev.)
- Operating system revision index (OS-Rev.)
- Supply voltage (Power)
- Ex specifications (if applicable)
- Production year (Prod-Year:)



Figure 1: Sample Type Label

3.4 Structure

The module is equipped with 32 digital outputs. The outputs are not galvanically separated from one another and from the supply voltage.

The module is equipped with a current limiting function, which limits the total current of all the 32 outputs. Additionally, the module monitors the total current for overload. If an overload is present for longer than 100 ms, all the outputs are switched off and switched on again after ten seconds. If the overload is still present, all the outputs are switched off again for ten seconds. This process is repeated as long as the overload is present.

If an output overload is detected, the corresponding channel is switched off and automatically switched on again after five seconds as soon as the overload is no longer present.

The processor system within the I/O module controls and monitors the I/O level. The data and states of the I/O module are provided to the processor modules via the redundant system bus. The system bus has a redundant structure for reasons of availability. Redundancy is only ensured if both system bus modules are inserted in the base plates and configured in SILworX.

The module is equipped with LEDs to indicate the status of the digital outputs, see Chapter 3.4.2.

3.4.1 Block Diagram

The following block diagram illustrates the structure of the module:

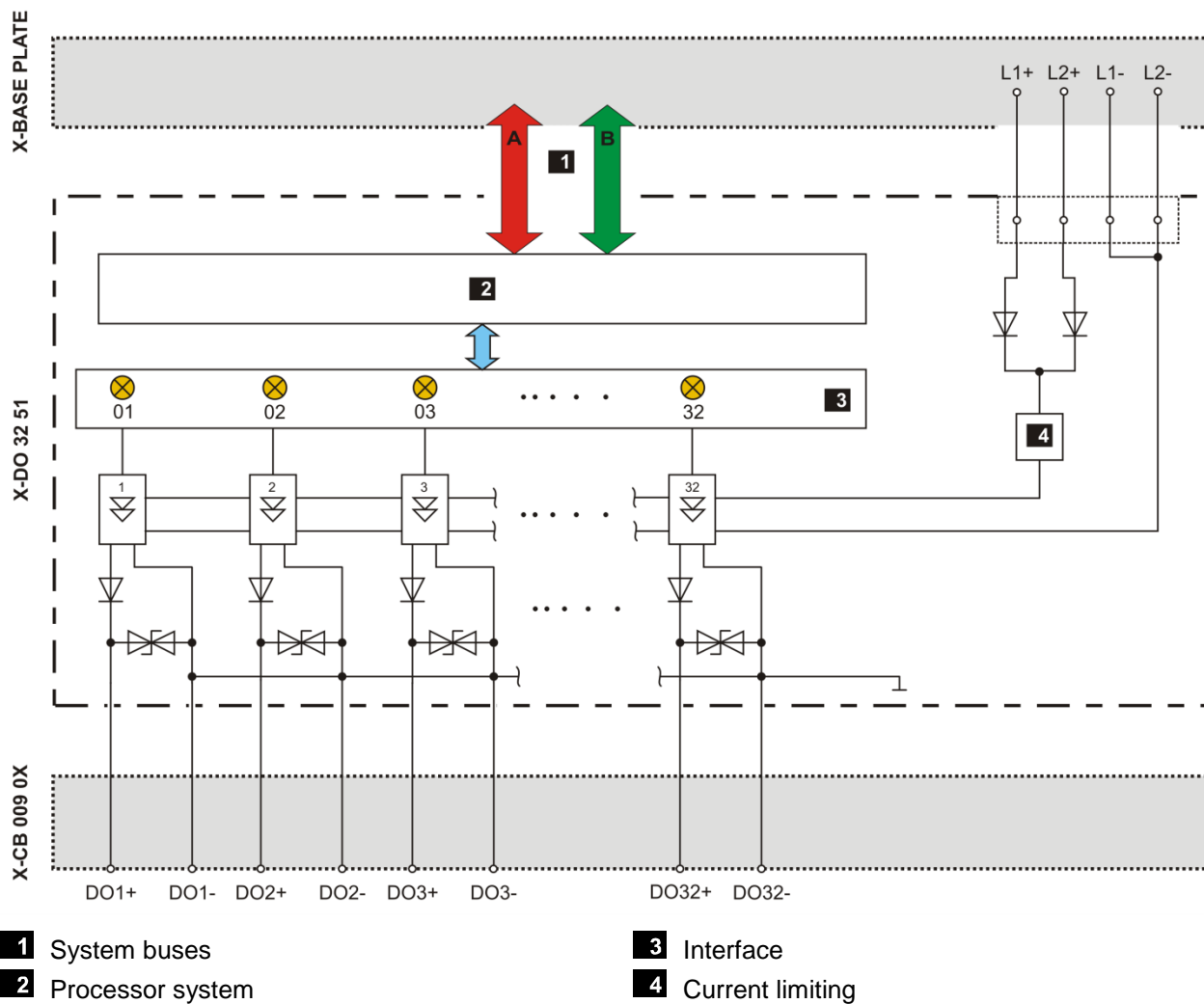


Figure 2: Block Diagram

3.4.2 Indicators

The following figure shows the front view of the module with the LEDs:

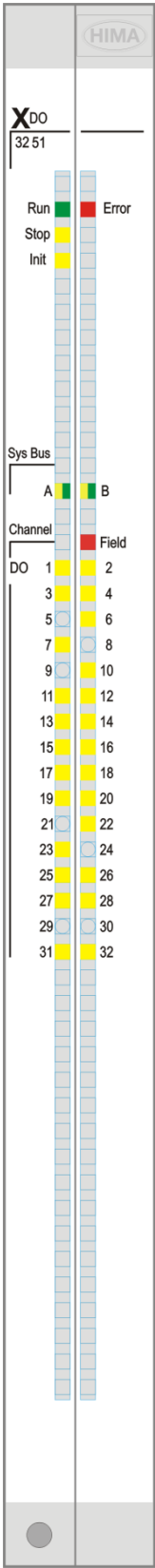


Figure 3: Indicators

The LEDs indicate the operating state of the module. All LEDs should be considered together. The LEDs on the module are divided into the following groups:

- Module status indicators (Run, Error, Stop, Init)
- System bus indicators (A, B)
- I/O indicators (DO 1...32, Field)

After connecting the supply voltage, an LED test is performed and all the LEDs are lit for at least 2 s. The color of two-color LEDs changes once during the test.

Definition of blinking frequencies

The following table defines the blinking frequencies:

Definition	Blinking frequencies
Blinking1	Long (600 ms) on, long (600 ms) off.
Blinking2	Short (200 ms) on, short (200 ms) off, short (200 ms) on, long (600 ms) off.
Blinking-x	Ethernet communication: Blinking synchronously with data transmission.

Table 2: Blinking Frequencies of the LEDs

Some LEDs can report warnings (On) and faults or errors (Blinking1), see the following tables. The indication of errors or faults has priority over the indication of warnings. Warnings cannot be reported if errors or faults are being signaled.

3.4.3 Module Status Indicators

These LEDs are located on the upper part of the front plate.

LED	Color	Status	Description
Run	Green	On	Module in the RUN state, normal operation.
		Blinking1	Module state STOP / LOADING OS
		Off	Module not in the RUN state, observe the other status LEDs.
Error	Red	On	System warning, for example: <ul style="list-style-type: none"> No license for additional functions (e.g., communication protocols), test mode. Temperature warning
		Blinking1	System error, for example: <ul style="list-style-type: none"> Internal module faults detected by self-tests, e.g., hardware or voltage supply faults. Fault while loading the operating system.
		Off	No faults detected
Stop	Yellow	On	Module state STOP / VALID CONFIGURATION
		Blinking1	The module is in one of the following states: <ul style="list-style-type: none"> STOP / INVALID CONFIGURATION STOP / LOADING OS
		Off	Module not in the STOP state, observe the other status LEDs.
Init	Yellow	On	Module state: INIT
		Blinking1	The module is in one of the following states: <ul style="list-style-type: none"> LOCKED STOP / LOADING OS
		Off	Module is in none of the states described, observe the other status LEDs.

Table 3: Module Status Indicators

3.4.4 System Bus Indicators

The system bus indicator LEDs are labeled *Sys Bus*.

LED	Color	Status	Description
A	Green	On	Physical and logical connection to the system bus module in slot 1.
		Blinking1	No physical connection to the system bus module in slot 1.
	Yellow	Blinking1	The physical connection to the system bus module in slot 1 has been established. No connection to a (redundant) processor module running in system operation.
B	Green	On	Physical and logical connection to the system bus module in slot 2.
		Blinking1	No physical connection to the system bus module in slot 2.
	Yellow	Blinking1	The physical connection to the system bus module in slot 2 has been established. No connection to a (redundant) processor module running in system operation.
A+B	Off	Off	Neither physical nor logical connection to the system bus modules in slot 1 and slot 2.

Table 4: System Bus Indicators

3.4.5 I/O Indicators

The LEDs of the I/O indicators are labeled *Channel*.

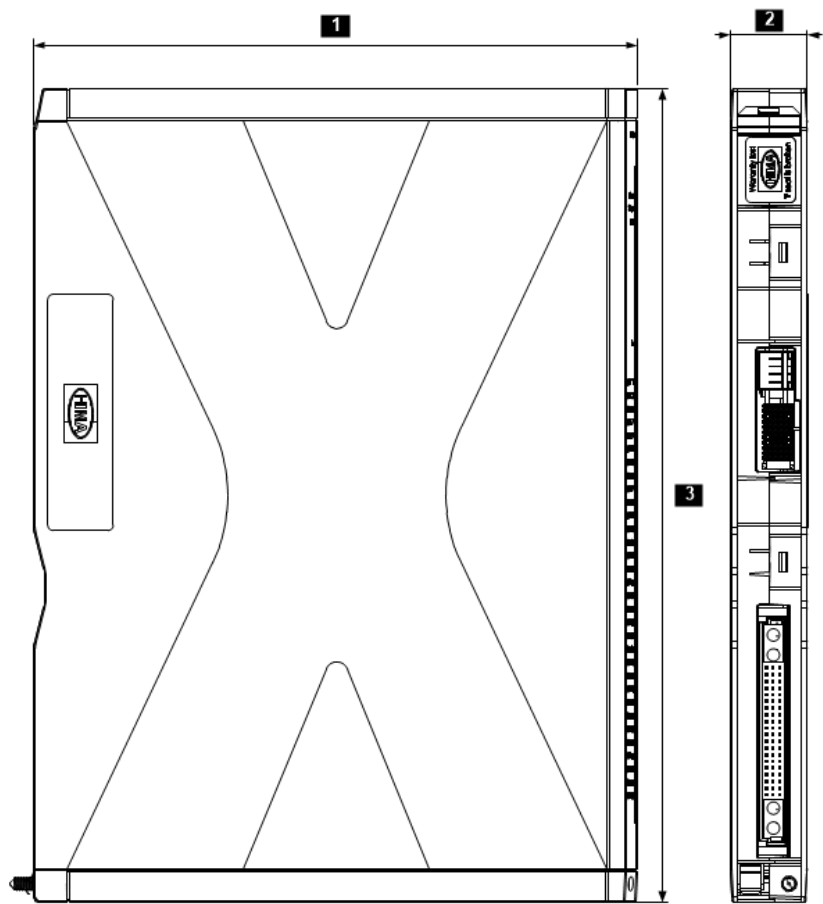
LED	Color	Status	Description
DO 1...32	Yellow	On	The corresponding channel is active (energized).
		Blinking2	Channel fault.
		Off	The corresponding channel is not active (de-energized).
Field	Red	Blinking2	Field faults in at least one channel (e.g., overload).
		Off	No faults at the field level.

Table 5: I/O Indicators

3.5 Product Data

General information	
Supply voltage	24 VDC, -15...+20 %, $r_p \leq 5$ % SELV, PELV
Current consumption	0.2 mA at 24 VDC
Continuous load	12.5 A at 24 VDC
Module cycle time	2 ms
Protection class	Protection class III in accordance with IEC/EN 61131-2
Ambient temperature	0...+60 °C
Transport and storage temperature	-40...+70 °C
Humidity	Max. 95 % relative humidity, non-condensing
Pollution	Pollution degree II in accordance with IEC/EN 60664-1
Installation height	< 2000 m
Degree of protection	IP20
Dimensions (H x W x D) in mm	310 x 29.2 x 230
Weight	Approx. 1.0 kg

Table 6: Product Data



- 1** Depth: 230 mm
- 2** Width: 29.2 mm

- 3** Height: 310 mm

Figure 4: Views

Digital outputs	
Number of outputs (number of channels)	32, not galvanically separated
Output voltage	$\geq L+$ minus internal voltage drop
Voltage drop (with high level)	1.8 V at 0.7 A output current
Nominal rated current (with high level)	0.5 A, range 0...0.6 A
Leakage current (at low level)	$< 500 \mu\text{A}$
Max. output current for each channel	0.7 A
Permissible total output current	12 A
Current limiting for total output current	16 A
Behavior upon overload of the total output current	All outputs are switched off and cyclically switched on again, see Chapter 3.3.
Ohmic load	To nominal rated current 0.5 A
Inductive load	2 H
Capacitive load	100 μF
Lamp load (24 V)	4 W
Overload protection of the outputs, transient	33 V (max. 43 V)
Switching time of the channels (with ohmic load)	$\leq 100 \mu\text{s}$
Behavior upon overload of individual outputs	The affected output is switched off

Table 7: Specifications for the Digital Outputs

3.6 Connector Boards

A connector board connects the module to the field level. Module and connector board together form a functional unit. Insert the connector board into the appropriate slot prior to mounting the module.

The following connector boards are available for the module:

Designation	Description
X-CB 009 51	Mono connector board with screw terminals.
X-CB 009 52	Redundant connector board with screw terminals.
X-CB 009 53	Mono connector board with cable plug.
X-CB 009 54	Redundant connector board with cable plug.

Table 8: Available Connector Boards

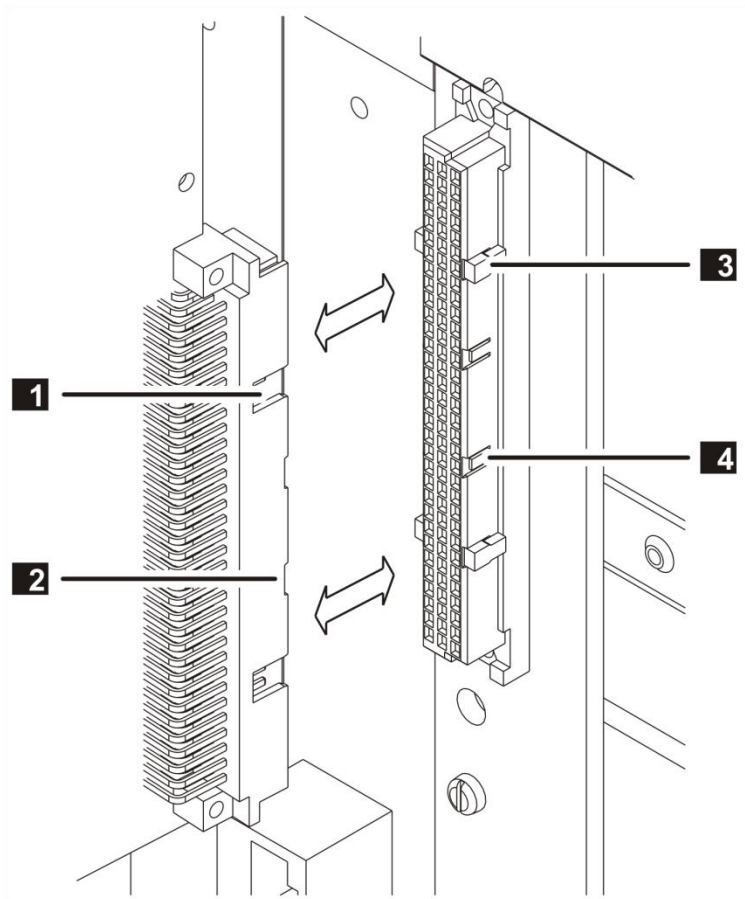
3.6.1 Mechanical Coding of Connector Boards

I/O modules and connector boards are mechanically coded starting from hardware revision index (HW-Rev.) 00. Coding avoids installation of improper I/O modules thus preventing negative effects on redundant modules and the field level.

Apart from that, improper equipment has no effect on the HiMax system since only I/O modules properly configured in SILworX can enter the RUN state.

I/O modules and the corresponding connector boards have a mechanical coding in the form of wedges. The coding wedges in the female connector of the connector board match with the male connector recesses of the I/O module plug, see Figure 5.

Coded I/O modules can only be plugged in to the corresponding connector boards.



- 1** Male connector recess
- 2** Prepared male connector recess
- 3** Coding wedge
- 4** Guideway for coding wedge

Figure 5: Coding Example

Coded I/O modules can be plugged in to uncoded connector boards. Uncoded I/O modules cannot be plugged in to coded connector boards.

3.6.2 Coding of X-CB 009 5x Connector Boards

The following table specifies the position of the coding wedges on the I/O module plug:

a7	a13	a20	a26	c7	c13	c20	c26
X	X	X				X	

Table 9: Position of Coding Wedges

3.6.3 Connector Boards with Screw Terminals

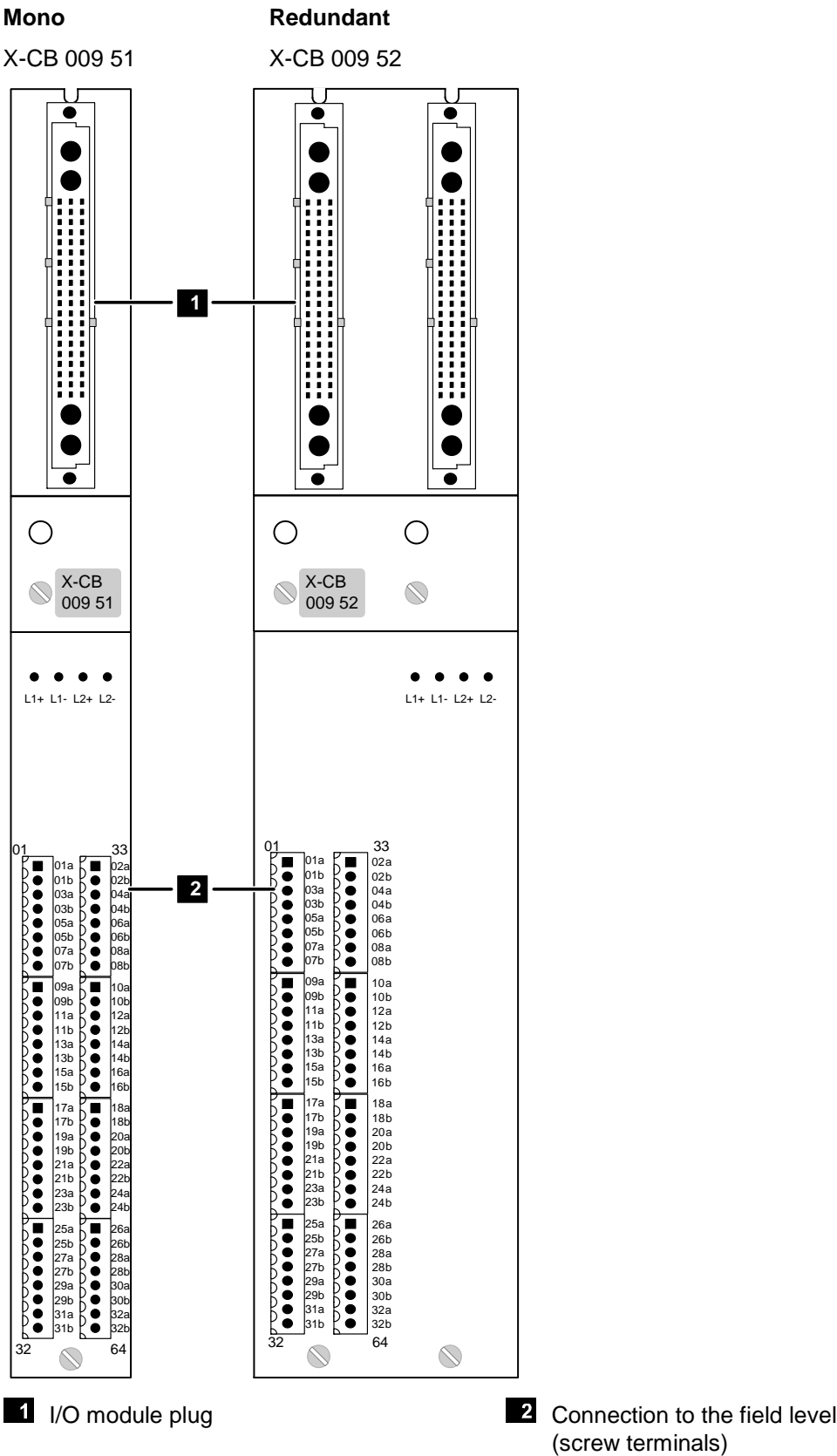


Figure 6: Connector Boards with Screw Terminals

3.6.4 Terminal Assignment for Connector Boards with Screw Terminals

Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	01a	DO1+	1	02a	DO2+
2	01b	DO1-	2	02b	DO2-
3	03a	DO3+	3	04a	DO4+
4	03b	DO3-	4	04b	DO4-
5	05a	DO5+	5	06a	DO6+
6	05b	DO5-	6	06b	DO6-
7	07a	DO7+	7	08a	DO8+
8	07b	DO7-	8	08b	DO8-
Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	09a	DO9+	1	10a	DO10+
2	09b	DO9-	2	10b	DO10-
3	11a	DO11+	3	12a	DO12+
4	11b	DO11-	4	12b	DO12-
5	13a	DO13+	5	14a	DO14+
6	13b	DO13-	6	14b	DO14-
7	15a	DO15+	7	16a	DO16+
8	15b	DO15-	8	16b	DO16-
Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	17a	DO17+	1	18a	DO18+
2	17b	DO17-	2	18b	DO18-
3	19a	DO19+	3	20a	DO20+
4	19b	DO19-	4	20b	DO20-
5	21a	DO21+	5	22a	DO22+
6	21b	DO21-	6	22b	DO22-
7	23a	DO23+	7	24a	DO24+
8	23b	DO23-	8	24b	DO24-
Pin no.	Designation	Signal	Pin no.	Designation	Signal
1	25a	DO25+	1	26a	DO26+
2	25b	DO25-	2	26b	DO26-
3	27a	DO27+	3	28a	DO28+
4	27b	DO27-	4	28b	DO28-
5	29a	DO29+	5	30a	DO30+
6	29b	DO29-	6	30b	DO30-
7	31a	DO31+	7	32a	DO32+
8	31b	DO31-	8	32b	DO32-

Table 10: Terminal Assignment for Connector Boards with Screw Terminals

Cable plugs attached to the connector board pin headers are used to connect to the field level.

The cable plugs feature the following characteristics:

Connection to the field level	
Cable plugs	8 pieces, with 8 poles
Wire cross-section	0.2...1.5 mm ² (single-wire) 0.2...1.5 mm ² (finely stranded) 0.2...1.5 mm ² (with wire end ferrule)
Stripping length	6 mm
Screwdriver	Slotted 0.4 x 2.5 mm
Tightening torque	0.2...0.25 Nm

Table 11: Cable Plug Characteristics

3.6.5 Connector Boards with Cable Plug

Mono

X-CB 009 53

Redundant

X-CB 009 54

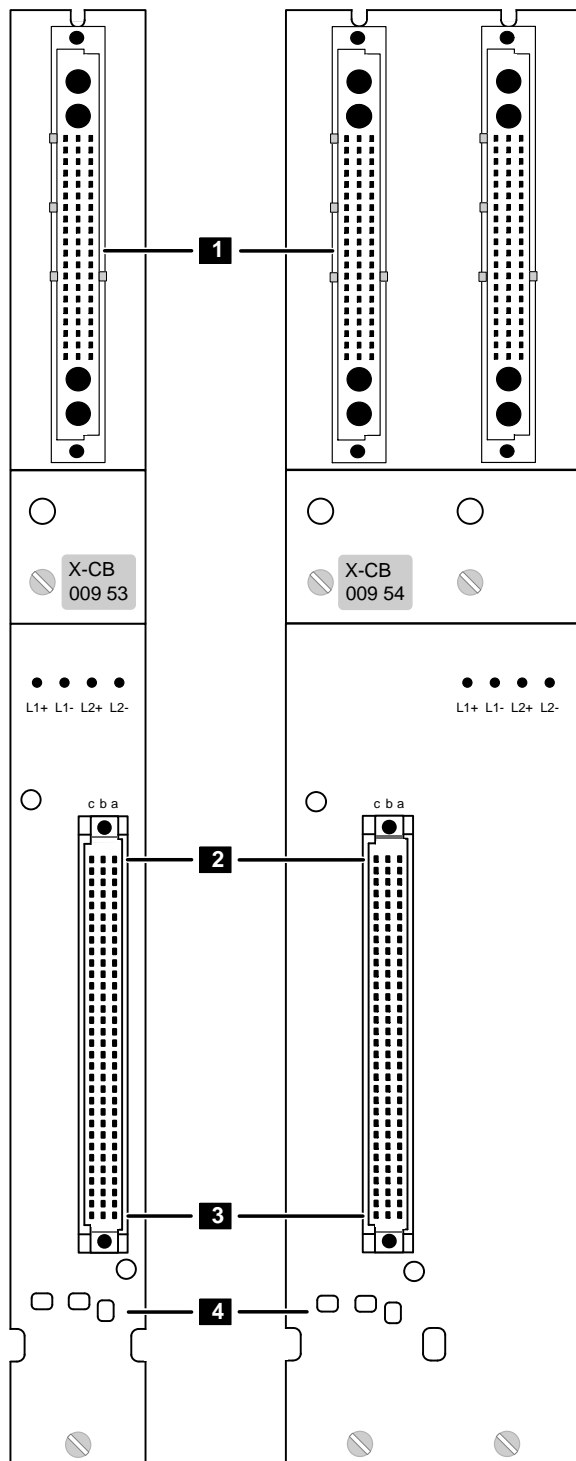
**1** I/O module plug**2** Connection to the field level
(cable plug in row 1)**3** Connection to the field level
(cable plug in row 32)**4** Coding of cable plugs

Figure 7: Connector Boards with Cable Plug

3.6.6 Pin Assignment for Connector Boards with Cable Plug

HIMA provides ready-made system cables for use with this connector board, see Chapter 3.7. The cable plug and the connector board are coded.

i

Connector pin assignment!

The following table describes the connector pin assignment of the system cable plug.

The wire color coding complies with IEC 60304. The color abbreviations used are in accordance with IEC 60757.

Row	c		b		a	
	Signal	Color	Signal	Color	Signal	Color
1	DO32+	PKBN ¹⁾	DO32-	WHPK ¹⁾	Internal use ³⁾	BNRD ²⁾
2	DO31+	GYBN ¹⁾	DO31-	WHGY ¹⁾		WHRD ²⁾
3	DO30+	YEBN ¹⁾	DO30-	WHYE ¹⁾		BNBU ²⁾
4	DO29+	BNGN ¹⁾	DO29-	WHGN ¹⁾		WHBU ²⁾
5	DO28+	RDBU ¹⁾	DO28-	GYPK ¹⁾		
6	DO27+	VT ¹⁾	DO27-	BK ¹⁾		
7	DO26+	RD ¹⁾	DO26-	BU ¹⁾		
8	DO25+	PK ¹⁾	DO25-	GY ¹⁾		
9	DO24+	YE ¹⁾	DO24-	GN ¹⁾		
10	DO23+	BN ¹⁾	DO23-	WH ¹⁾		
11	DO22+	RDBK	DO22-	BUBK		
12	DO21+	PKBK	DO21-	GYBK		
13	DO20+	PKRD	DO20-	GYRD		
14	DO19+	PKBU	DO19-	GYBU		
15	DO18+	YEBK	DO18-	GNBK		
16	DO17+	YERD	DO17-	GNRD		
17	DO16+	YEBU	DO16-	GNBU		
18	DO15+	YEPK	DO15-	PKGN		
19	DO14+	YEGY	DO14-	GYGN		
20	DO13+	BNBK	DO13-	WHBK		
21	DO12+	BNRD	DO12-	WHRD		
22	DO11+	BNBU	DO11-	WHBU		
23	DO10+	PKBN	DO10-	WHPK		
24	DO9+	GYBN	DO9-	WHGY		
25	DO8+	YEBN	DO8-	WHYE		
26	DO7+	BNGN	DO7-	WHGN		
27	DO6+	RDBU	DO6-	GYPK		
28	DO5+	VT	DO5-	BK		
29	DO4+	RD	DO4-	BU		
30	DO3+	PK	DO3-	GY		
31	DO2+	YE	DO2-	GN		
32	DO1+	BN	DO1-	WH		

¹⁾ For the first repeated wire color coding: Additional orange ring.
²⁾ For the second repeated wire color coding: Additional violet ring.
³⁾ The wires must be isolated individually! No other use is permitted!

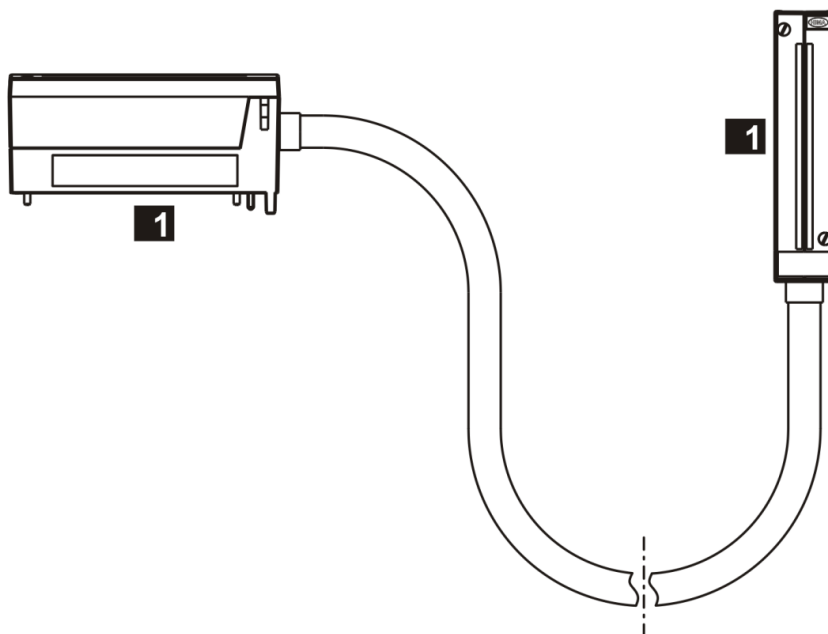
Table 12: Pin Assignment for the Cable Plugs of System Cable X-CA 006

3.7 System Cable X-CA 006

System cable X-CA 006 is used to connect the X-CB 009 53/54 connector board to the field termination assembly.

General information	
Cable	LIYY 64 x 0.34 mm ² + 2 x 2 x 0.25 mm ²
Wire	Finely stranded
Average outer diameter (d)	Approx. 17.2 mm, max. 20 mm for all types of system cables
Minimum bending radius	
Fixed installation	5 x d
Flexible application	10 x d
Burning behavior	Flame retardant and self-extinguishing in accordance with IEC 60332-1-2, IEC 60332-2-2
Length	8...30 m
Color coding	Based on DIN 47100, see Table 12

Table 13: Cable Data



1 Identical cable plugs

Figure 8: X-CA 006 01 n

The system cable is available in the following standard lengths:

System cables	Description	Length	Weight
X-CA 006 01 8	Coded cable plugs on both sides.	8 m	4.25 kg
X-CA 006 01 15		15 m	8 kg
X-CA 006 01 30		30 m	16 kg

Table 14: Available System Cables

3.7.1 Cable Plug Coding

The cable plugs are equipped with three coding pins. Therefore, cable plugs only match connector boards and FTAs encoded accordingly, see Figure 7.

4 Start-Up

This chapter describes how to install, configure and connect the module. For further details, refer to the HIMax system manual (HI 801 001 E).

4.1 Mounting

Observe the following points when mounting the module:

- Only operate the module with the appropriate fan components. For further details, see the system manual (HI 801 001 E).
- Only operate the module with the suitable connector board. For further details, see Chapter 3.6.
- The module, including its connected components, must be installed to ensure compliance with the requirements for degree of protection IP20 or higher in accordance with EN 60529:1991 + A1:2000.

NOTICE



Damage due to incorrect wiring!

Failure to comply with these instructions can damage the electronic components.

Observe the following points.

- Plugs and terminals connected to the field level.
 - Take the appropriate grounding measures when connecting the plugs and terminals to the field level.
 - An unshielded, twisted pair cable may be used for connecting field current circuits to the digital outputs.
 - On the module side, the shielding must be connected to the cable shield rail (use SK 20 shield connection terminal block or similar).
 - If finely stranded wires are used, HIMA recommends fastening ferrules to the wire ends. The terminals must be suitable for fastening the cross-sections of the cables in use.
- A redundant output wiring is possible using the X-FTA 002 02, Chapter 4.3.1.

4.1.1 Wiring Unused Outputs

Outputs that are not being used may stay open and need not be terminated. To prevent short-circuits and sparks in the field, never connect a wire to a connector board if it is open on the field level.

4.2 Mounting and Removing the Module

This chapter describes how to replace an existing module or mount a new one.

When removing the module, the connector board remains in the HiMax base plate. This saves additional wiring effort at the clamp terminals since all field terminals are connected via the connector board of the module.

4.2.1 Mounting a Connector Board

Tools and utilities:

- Screwdriver, cross PH 1 or slotted 0.8 x 4.0 mm.
- Matching connector board.

To install the connector board

1. Insert the connector board into the guiding rail with the groove facing upwards (see following drawing). Fit the groove into the guiding rail pin.
2. Place the connector board on the cable shield rail.
3. Secure the captive screws to the base plate. First screw in the lower screws than the upper ones.

To remove the connector board

1. Release the captive screws from the base plate.
2. Carefully lift the lower section of the connector board from the cable shield rail.
3. Remove the connector board from the guiding rail.

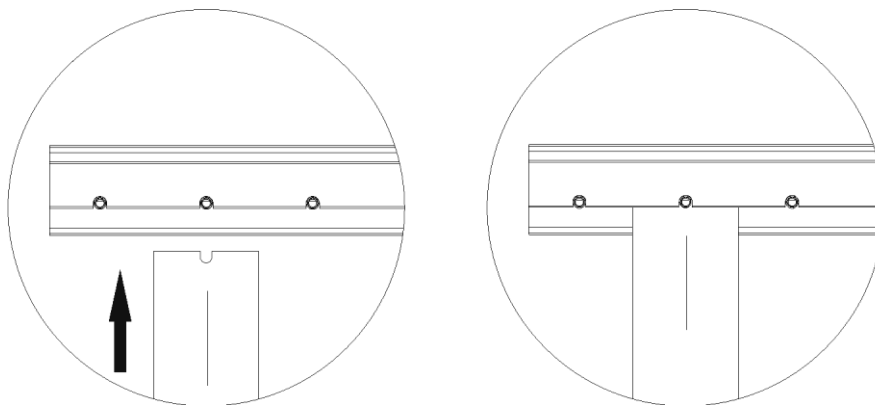


Figure 9: Example of how to Insert the Mono Connector Board

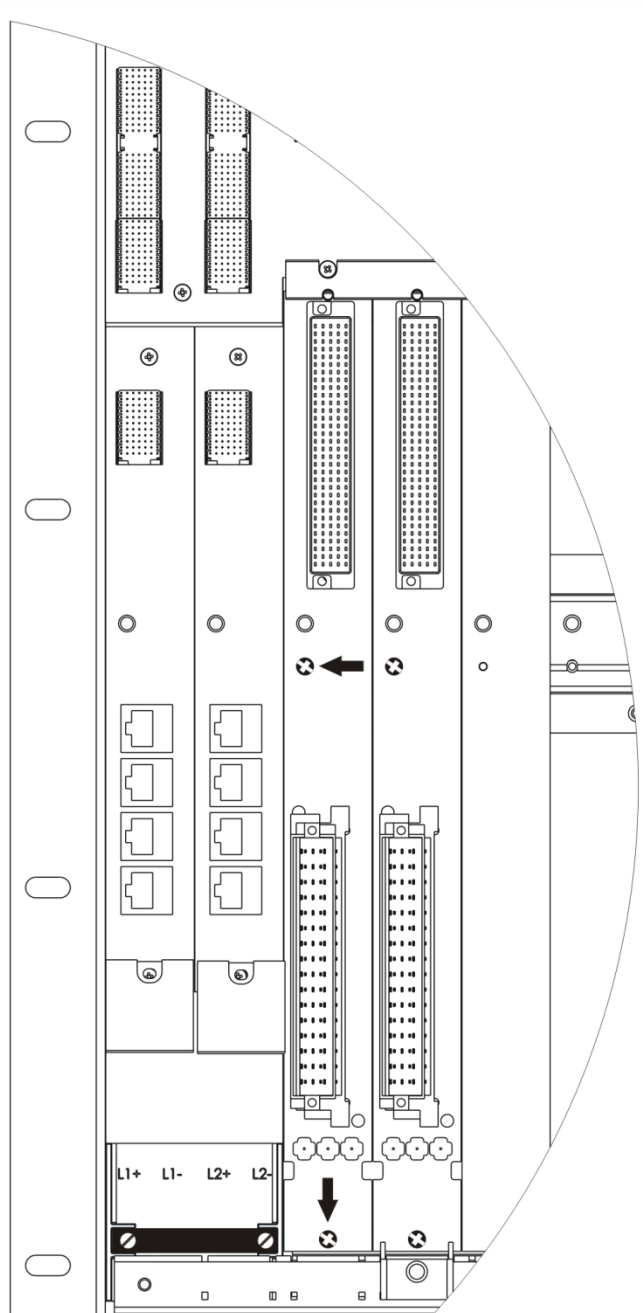


Figure 10: Example of how to Secure the Mono Connector Board with Captive Screws

i

These instructions also apply for redundant connector boards. The number of used slots varies in accordance with the connector board type. The number of captive screws depends on the connector board type.

4.2.2 Mounting and Removing a Module

This chapter describes how to mount and remove the HIMax module. A module can be mounted and removed while the HIMax system is operating.

NOTICE



Damage to bus and power sockets due to module jamming!

Failure to comply with these instructions can damage the controller.

Always insert the module in the base plate carefully.

Tools and utilities:

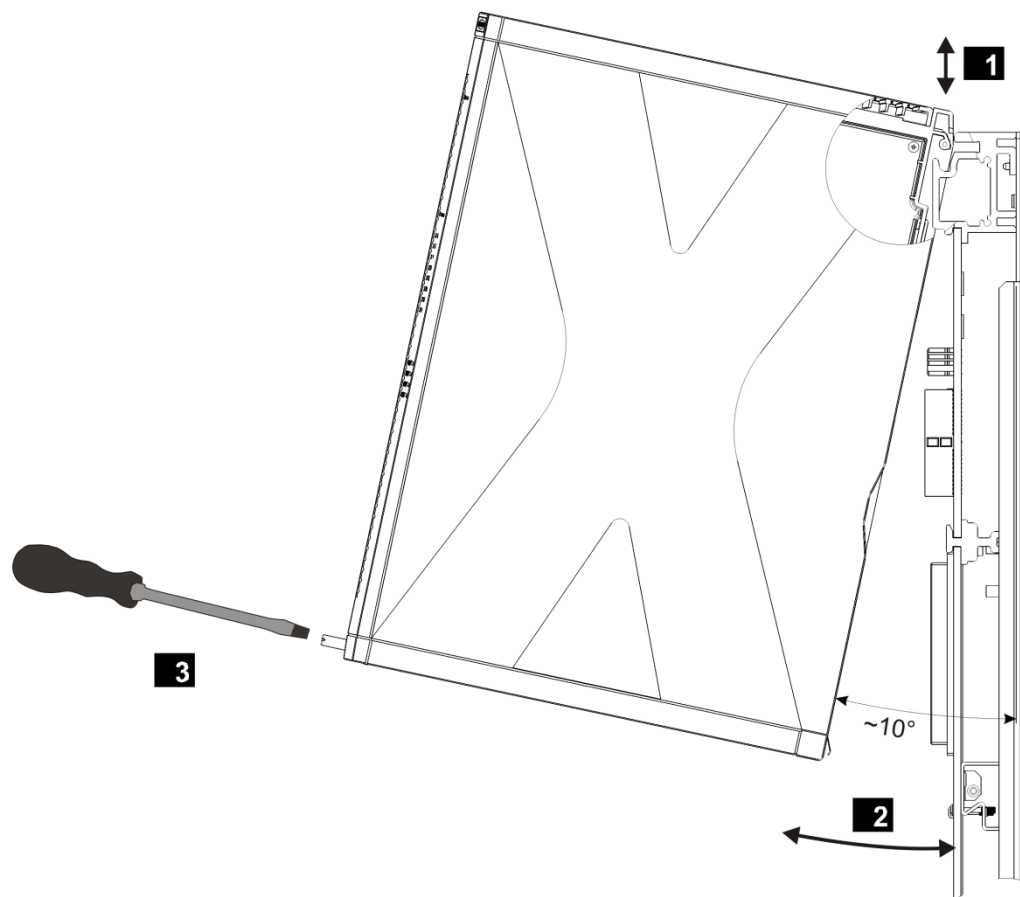
- Screwdriver, slotted 0.8 x 4.0 mm.
- Screwdriver, slotted 1.2 x 8.0 mm.

To insert the modules

1. Open the cover plate on the fan rack:
 - ☒ Move the locks to the *open* position.
 - ☒ Lift the cover plate and insert it into the fan rack.
2. Insert the top of the module into the hook-in rail, see **1**.
3. Swivel the lower edge of the module towards the base plate and apply light pressure to snap it into place, see **2**.
4. Tighten the screws, see **3**.
5. Pull the cover plate out of the fan rack and close it.
6. Lock the cover plate.

To remove the modules

1. Open the cover plate on the fan rack:
 - ☒ Move the locks to the *open* position.
 - ☒ Lift the cover plate and insert it into the fan rack.
2. Release the screw, see **3**.
3. Swivel the lower edge of the module away from the base plate. Lift and apply light pressure to remove the module from the hook-in rail, see **2** and **1**.
4. Pull the cover plate out of the fan rack and close it.
5. Lock the cover plate.



- 1** Inserting and removing a module
- 2** Swiveling the module in and out

- 3** Securing and releasing a module

Figure 11: Mounting and Removing a Module

i

If the HIMax system is operating, do not open the cover plate of the fan rack for more than a few minutes (< 10 min) since this affects the forced cooling.

4.3 Configuring the Module in SILworX

The module is configured in the Hardware Editor of the SILworX programming tool.

Observe the following points when configuring the module:

- To diagnose the module and channels, both the system parameters and the channel value can be evaluated within the user program. For further details on the system parameters, refer to the following tables.
- If a redundancy group is created, its configuration is defined in the tabs. The tabs specific to the redundancy group differ from those of the individual modules, see the following tables.

To evaluate the system parameters in the user program, they must be assigned to global variables. Perform this step in the Hardware Editor using the module's detail view.

The following tables present the system parameters for the module in the same order as in the SILworX Hardware Editor.

TIP

A scientific calculator such as the Windows® calculator with the corresponding view can be used to convert hexadecimal values to bit strings.

4.3.1 The **Module** Tab

The **Module** tab contains the following system parameters for the module:

System parameter	Data type	R/W	Description																				
Name	---	W	Module name.																				
Spare Module	BOOL	W	Activated: It is not considered a fault if a module of the redundancy group is missing in the base plate. Deactivated: It is considered a fault if a module of the redundancy group is missing in the base plate. Default setting: Deactivated It is only displayed in the redundancy group tab!																				
Noise Blanking	BOOL	W	Allow noise blanking performed by the process module (Activated/Deactivated). Default setting: Activated The processor module delays its response to transient interference until the safety time. The user program retains its last valid process value. Refer to the system manual (HI 801 001 E) for further details on noise blanking.																				
System parameter	Data type	R/W	Description																				
The following statuses and parameters can be assigned global variables and used in the user program.																							
Module OK	BOOL	R	TRUE: Mono operation: No module faults. Redundancy operation: At least one of the redundant modules has no module fault (OR logic). FALSE: Module fault. Channel fault (no external faults). The module is not plugged in. Observe the <i>Module Status</i> parameter!																				
Module Status	DWORD	R	Status of the module. <table><tr><th>Coding</th><th>Description</th></tr><tr><td>0x00000001</td><td>Module fault. ¹⁾</td></tr><tr><td>0x00000002</td><td>Temperature threshold 1 exceeded.</td></tr><tr><td>0x00000004</td><td>Temperature threshold 2 exceeded.</td></tr><tr><td>0x00000008</td><td>Incorrect temperature value.</td></tr><tr><td>0x00000010</td><td>Voltage on L1+ is defective.</td></tr><tr><td>0x00000020</td><td>Voltage on L2+ is defective.</td></tr><tr><td>0x00000040</td><td>Internal voltage is defective.</td></tr><tr><td>0x80000000</td><td>No connection to the module.¹⁾</td></tr><tr><td colspan="2">¹⁾ These faults affect the <i>Module OK</i> status and need not be separately evaluated in the user program.</td></tr></table>	Coding	Description	0x00000001	Module fault. ¹⁾	0x00000002	Temperature threshold 1 exceeded.	0x00000004	Temperature threshold 2 exceeded.	0x00000008	Incorrect temperature value.	0x00000010	Voltage on L1+ is defective.	0x00000020	Voltage on L2+ is defective.	0x00000040	Internal voltage is defective.	0x80000000	No connection to the module. ¹⁾	¹⁾ These faults affect the <i>Module OK</i> status and need not be separately evaluated in the user program.	
Coding	Description																						
0x00000001	Module fault. ¹⁾																						
0x00000002	Temperature threshold 1 exceeded.																						
0x00000004	Temperature threshold 2 exceeded.																						
0x00000008	Incorrect temperature value.																						
0x00000010	Voltage on L1+ is defective.																						
0x00000020	Voltage on L2+ is defective.																						
0x00000040	Internal voltage is defective.																						
0x80000000	No connection to the module. ¹⁾																						
¹⁾ These faults affect the <i>Module OK</i> status and need not be separately evaluated in the user program.																							
Timestamp [μs]	DWORD	R	Microsecond fraction of the timestamp. Point in time when the digital outputs were measured.																				
Timestamp [s]	DWORD	R	Second fraction of the timestamp. Point in time when the digital outputs were measured.																				

Table 15: The **Module** Tab in the Hardware Editor

4.3.2 The I/O Submodule DO 32_51 Tab

The I/O Submodule DO32_51 tab contains the following system parameters.

System parameter	Data type	R/W	Description
Enter these statuses and parameters directly in the Hardware Editor.			
Name	---	W	Tab name
System parameter	Data type	R/W	Description
The following statuses and parameters can be assigned global variables and used in the user program.			
Diagnostic Request	DINT	W	To request a diagnostic value, the appropriate ID must be sent to the module using the parameter <i>Diagnostic Request</i> (for coding details, see Chapter 4.3.5).
Diagnostic Response	DINT	R	As soon as <i>Diagnostic Response</i> returns the ID of <i>Diagnostic Request</i> (for coding details, see Chapter 4.3.5), <i>Diagnostic Status</i> contains the diagnostic value requested.
Diagnostic Status	DWORD	R	Requested diagnostic value in accordance with <i>Diagnostic Response</i> . The IDs of <i>Diagnostic Request</i> and <i>Diagnostic Response</i> can be evaluated in the user program. <i>Diagnostic Status</i> only contains the requested diagnostic value when both <i>Diagnostic Request</i> and <i>Diagnostic Response</i> have the same ID.
Background Test Error	BOOL	R	TRUE: Background test is faulty. FALSE: Background test is not faulty.
Restart on Error	BOOL	W	The <i>Restart on Error</i> parameter can be used to cause any I/O module that is shut down permanently due to errors or faults to once again enter the RUN state. To do so, set the <i>Restart on Error</i> parameter from FALSE to TRUE. The I/O module performs a complete self-test and only enters the RUN state if no faults are detected. Default setting: FALSE
Submodule OK	BOOL	R	TRUE: No submodule fault, no channel faults. FALSE: Submodule fault, channel faults (external faults included).
Submodule Status	DWORD	R	Bit-coded submodule status (for coding details, see 4.3.4)

Table 16: The I/O Submodule DO 32_51 Tab in the Hardware Editor

4.3.3 The I/O Submodule DO 32_51: Channels Tab

The **I/O Submodule DO32_51: Channels** tab contains the following system parameters for each digital output.

Global variables can be assigned to the system parameters with **->** and used in the user program. The value without **->** must be directly entered.

System parameter	Data type	R/W	Description
Channel no.	---	R	Channel number, preset and cannot be changed.
Channel Value [BOOL] ->	BOOL	R	Binary value in accordance with the switching levels LOW (dig) and HIGH (dig). TRUE: Channel energized. FALSE: Channel de-energized.
-> Channel OK [BOOL]	BOOL	R	TRUE: Fault-free channel. The channel value is valid. FALSE: Faulty channel. The channel is de-energized.
Redund.	BOOL	W	Requirement: The redundant module must exist. Activated: The channel redundancy for this channel is active. Deactivated: Deactivate the channel redundancy for this channel. Default setting: Deactivated

Table 17: The **I/O Submodule DO32_51: Channels** Tab in the Hardware Editor

4.3.4 Description of *Submodule Status [DWORD]*

The following table specifies the coding of the *Submodule Status* parameter:

Coding	Description
0x00000001	Fault in hardware unit (submodule).
0x00000004	Fault detected while configuring the hardware.
0x00000040	Overcurrent, module shutdown.
0x04000000	Voltage monitoring of L1+ LOW voltage defective.
0x10000000	Voltage monitoring of L2+: LOW voltage defective.
0x20000000	Voltage monitoring of AGND: voltage defective.

Table 18: Coding of *Submodule Status [DWORD]*

4.3.5 Description of *Diagnostic Status* [DWORD]

The following table specifies the coding of the *Diagnostic Status* parameter:

ID	Description								
0	Diagnostic values are indicated consecutively.								
100	Bit-coded temperature status. 0 = normal. Bit0 = 1: Temperature threshold 1 has been exceeded. Bit1 = 1: Temperature threshold 2 has been exceeded. Bit2 = 1: Fault in temperature measurement.								
101	Measured temperature (10 000 digits/ °C).								
200	Bit-coded voltage status. 0 = normal. Bit0 = 1: L1+ (24 V) is faulty. Bit1 = 1: L2+ (24 V) is faulty.								
201	Not used								
202									
203									
300	Comparator 24 V undervoltage (BOOL).								
1001...1032	Status of the channels 1...32 <table border="1"> <tr> <th>Coding</th><th>Description</th></tr> <tr> <td>0x0001</td><td>Fault occurred in hardware unit (submodule).</td></tr> <tr> <td>0x0002</td><td>Reset of an I/O bus.</td></tr> <tr> <td>0x0004</td><td>Overload, channel shutdown.</td></tr> </table>	Coding	Description	0x0001	Fault occurred in hardware unit (submodule).	0x0002	Reset of an I/O bus.	0x0004	Overload, channel shutdown.
Coding	Description								
0x0001	Fault occurred in hardware unit (submodule).								
0x0002	Reset of an I/O bus.								
0x0004	Overload, channel shutdown.								

Table 19: Coding for *Diagnostic Status* [DWORD]

4.4 Connection Variants

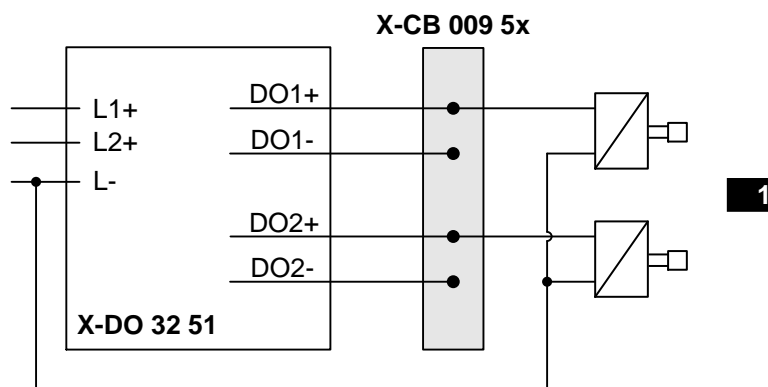
This chapter describes the technically proper wiring of the module. The following connection variants are permitted.

The outputs are wired via connector boards.

The following points must be taken into account when connecting the loads to the outputs:

- A protective circuit (such as a free-wheeling diode or varistor) is required when connecting inductive loads.
- Unshielded, twisted pairs of cables may be connected.

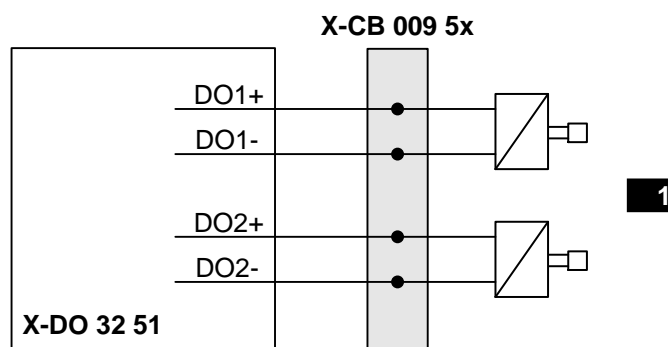
4.4.1 1-Pole Wiring of Actuators



1 Actuators

Figure 12: 1-Pole Wiring of Amplifiers and Actuators

4.4.2 2-Pole Wiring of Actuators

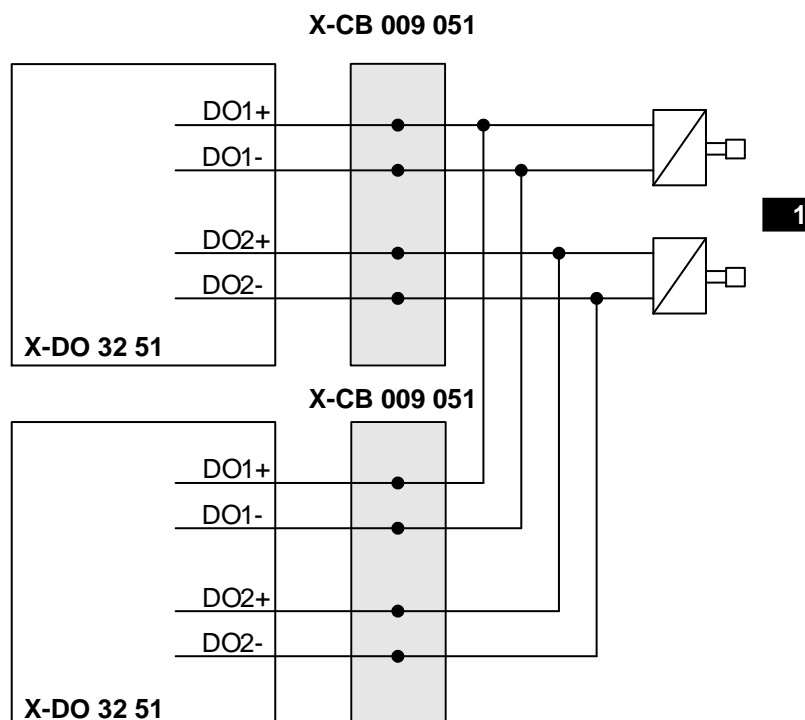


1 Actuators

Figure 13: 2-Pole Wiring of Actuators

4.4.3 Wiring Actuators to Redundant Modules

Actuators can be wired to redundant modules using 2 mono Connector Boards with screw terminals (XCB 009 51) as specified in Figure 14.



1 Actuators

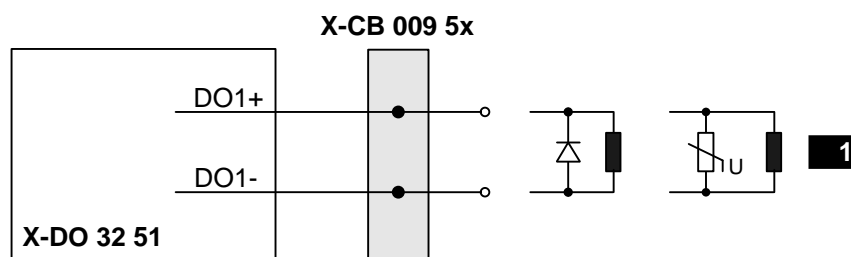
Figure 14: Redundant Wiring of Actuators

i

The wiring described above is only allowed if the two channels have identical channel numbers.

4.4.4 Wiring Inductive Loads

When connecting inductive loads, a protective circuit (such as a suitable free-wheeling diode) must be connected in parallel to the load.



1 Inductive load with protective circuits

Figure 15: Wiring for Inductive Loads

4.4.5 Connecting to Actuators via Field Termination Assembly

Actuators are connected via the X-FTA 002 01 as described in Figure 16. For further information, refer to the X-FTA 002 01 manual (HI 801 117 E).

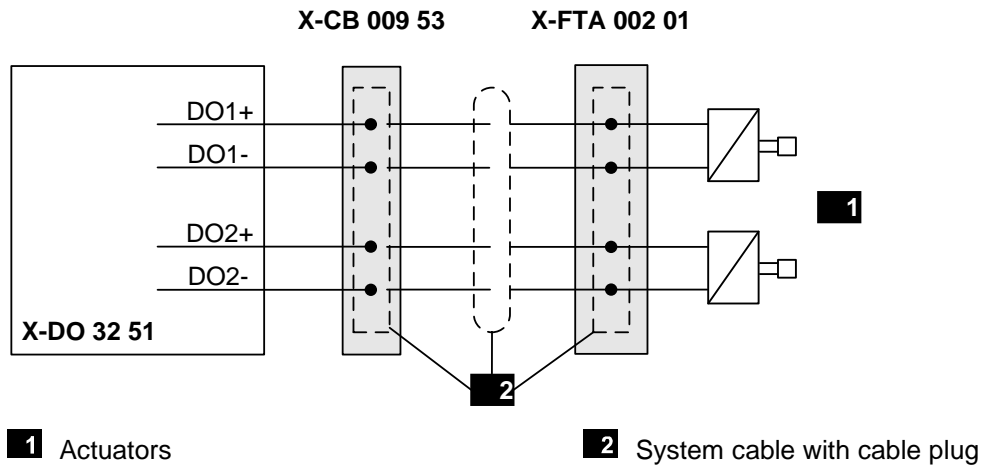


Figure 16: Connection to Actuators via Field Termination Assembly

5 Operation

The module runs within a HIMax base plate and does not require any specific monitoring.

5.1 Handling

Direct handling of the module is not foreseen.

The module is operated from within the PADT, e.g., for forcing the outputs. For further details, refer to the SILworX documentation.

5.2 Diagnostics

LEDs on the front side of the module indicate the module state, see Chapter 3.4.2.

The diagnostic history of the module can also be read out using SILworX. Chapter 4.3.4 and Chapter 4.3.5 describe the most important module-specific diagnostic messages.

i

If a module is plugged in to a base plate, it generates diagnostic messages during its initialization phase indicating faults such as incorrect voltage values.

These messages only indicate a module fault if they occur after the system starts operation.

6 Maintenance

Defective modules must be replaced with a faultless module of the same type or with an approved replacement model.

When replacing modules, observe the instructions specified in the system manual (HI 801 001 E).

6.1 Maintenance Measures

As part of product maintenance, HIMA is continuously improving the operating systems of the modules. HIMA recommends using system downtimes to load the current operating system versions into the modules.

i

The current operating system versions of modules are displayed in the SILworX Control Panel. The type label specifies the delivered module version, see Chapter 3.3.

Before loading operating systems into the modules, check the system compatibilities and restrictions of the operating system versions. To this end, use the applicable release notes. Use SILworX to load the operating systems into the modules and ensure that these are in the STOP state.

7 Decommissioning

To decommission the module, remove it from the base plate. For more details, refer to Chapter *Mounting and Removing the Module*.

8 Transport

To avoid mechanical damage, the components must be transported in packaging.

Always store the components in their original product packaging. This packaging also provides protection against electrostatic discharge (ESD). Note that the product packaging alone is not sufficient for transport.

9 Disposal

Industrial customers are responsible for correctly disposing of decommissioned hardware. Upon request, a disposal agreement can be arranged with HIMA.

All materials must be disposed of in an ecologically sound manner.



Appendix

Glossary

Term	Description
AI	Analog input
AO	Analog output
ARP	Address resolution protocol, network protocol for assigning the network addresses to hardware addresses
COM	Communication module
CRC	Cyclic redundancy check
DI	Digital input
DO	Digital output
EMC	Electromagnetic compatibility
EN	European standard
ESD	Electrostatic discharge
FB	Fieldbus
FBD	Function block diagrams
HW	Hardware
ICMP	Internet control message protocol, network protocol for status or error messages
IEC	International electrotechnical commission
Interference-free	Inputs are designed for interference-free operation and can be used in circuits with safety functions
MAC	Media access control address, hardware address of one network connection
PADT	Programming and debugging tool (in accordance with IEC 61131-3), PC with SILworX
PELV	Protective extra low voltage
PES	Programmable electronic system
R	Read, the variable is read out
R/W	Read/Write, column title for system variable type
Rack ID	Base plate identification (number)
i_P	Peak value of a total AC component
SB	System bus (module)
SC/OC	Short-circuit/open-circuit
SELV	Safety extra low voltage
SFF	Safe failure fraction, portion of faults that can be safely controlled
SIL	Safety integrity level (in accordance with IEC 61508)
SILworX	Programming tool
SNTP	Simple network time protocol (RFC 1769)
SRS	System.Rack.Slot, addressing of a module
SW	Software
TMO	Timeout
W	Write, the variable receives a value, e.g., from the user program
WD	Watchdog, device for monitoring the system's correct operation. Signal for fault-free process
WDT	Watchdog time

Index of Figures

Figure 1:	Sample Type Label	10
Figure 2:	Block Diagram	12
Figure 3:	Indicators	13
Figure 4:	Views	18
Figure 5:	Coding Example	21
Figure 6:	Connector Boards with Screw Terminals	22
Figure 7:	Connector Boards with Cable Plug	24
Figure 8:	X-CA 006 01 n	26
Figure 9:	Example of how to Insert the Mono Connector Board	28
Figure 10:	Example of how to Secure the Mono Connector Board with Captive Screws	29
Figure 11:	Mounting and Removing a Module	31
Figure 12:	1-Pole Wiring of Amplifiers and Actuators	37
Figure 13:	2-Pole Wiring of Actuators	37
Figure 14:	Redundant Wiring of Actuators	38
Figure 15:	Wiring for Inductive Loads	38
Figure 16:	Connection to Actuators via Field Termination Assembly	39

Index of Tables

Table 1:	Additional Applicable Manuals	5
Table 2:	Blinking Frequencies of the LEDs	14
Table 3:	Module Status Indicators	15
Table 4:	System Bus Indicators	16
Table 5:	I/O Indicators	16
Table 6:	Product Data	17
Table 7:	Specifications for the Digital Outputs	19
Table 8:	Available Connector Boards	20
Table 9:	Position of Coding Wedges	21
Table 10:	Terminal Assignment for Connector Boards with Screw Terminals	23
Table 11:	Cable Plug Characteristics	23
Table 12:	Pin Assignment for the Cable Plugs of System Cable X-CA 006	25
Table 13:	Cable Data	26
Table 14:	Available System Cables	26
Table 15:	The Module Tab in the Hardware Editor	33
Table 16:	The I/O Submodule DO 32_51 Tab in the Hardware Editor	34
Table 17:	The I/O Submodule DO32_51: Channels Tab in the Hardware Editor	35
Table 18:	Coding of <i>Submodule Status [DWORD]</i>	35
Table 19:	Coding for <i>Diagnostic Status [DWORD]</i>	36

Index

Block diagram	12	I/O indicators	16
Connection variant	38	System bus indicators	16
Connector board		Light emitting diodes, LEDs	14
with cable plug.....	24	Module status indicators	15
with screw terminals	22	Safety function	9
Connector Boards	20	Specifications.....	17
Diagnostics			

MANUAL
X-DO 32 51

HI 801 183 E

For further information, please contact:

HIMA Paul Hildebrandt GmbH

Albert-Bassermann-Str. 28
68782 Brühl, Germany

Phone: +49 6202 709-0
Fax +49 6202 709-107
E-mail: info@hima.com

Learn more about HIMax online:

 <https://www.hima.com/en/products-services/himax/>



www.hima.com